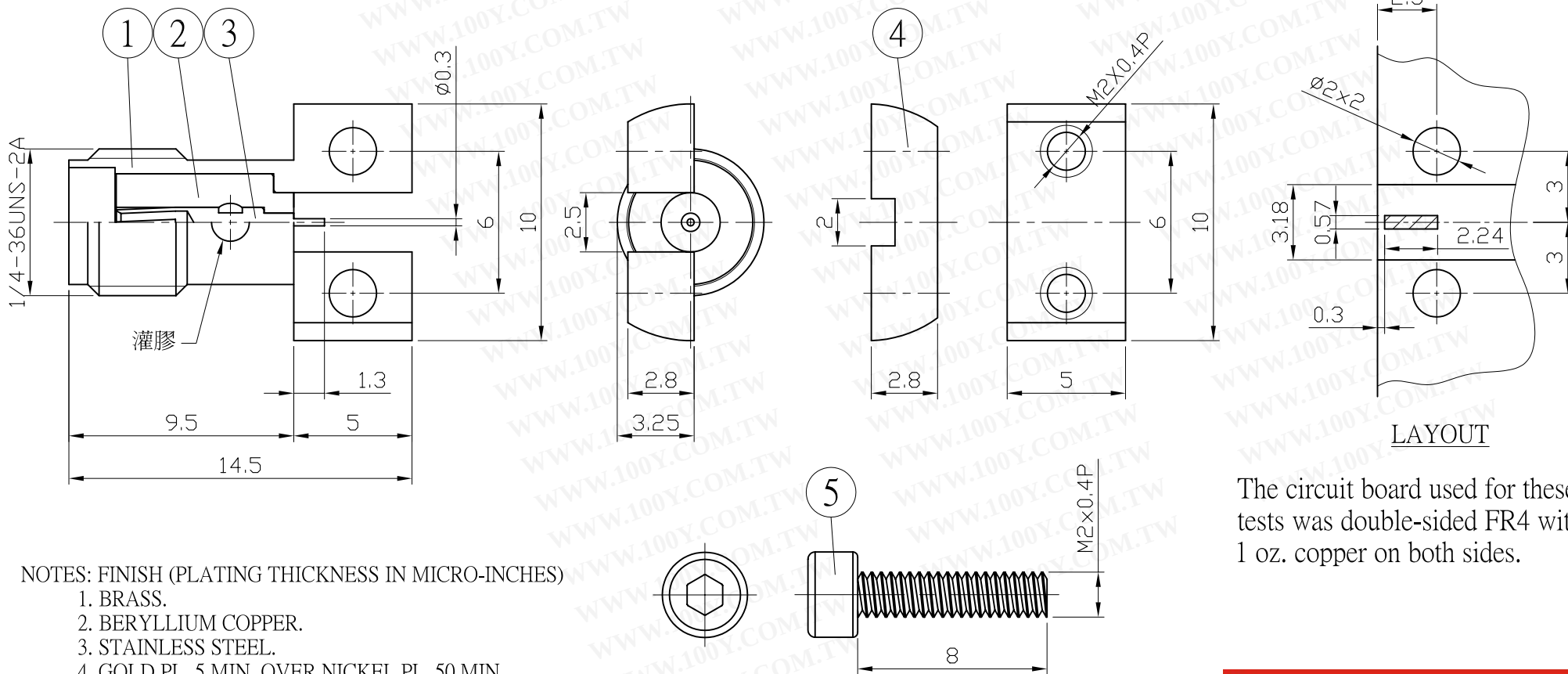


REVISION			
REV.	DESCRIPTION	DATE	APPROVED
-	INITIAL RELEASE	03/05/98"	



NOTES: FINISH (PLATING THICKNESS IN MICRO-INCHES)

1. BRASS.
2. BERYLLIUM COPPER.
3. STAINLESS STEEL.
4. GOLD PL. 5 MIN. OVER NICKEL PL. 50 MIN.
OVER COPPER PL. 50 MIN.
5. GOLD PL. 20 MIN. OVER NICKEL PL. 50 MIN.
OVER COPPER PL. 50 MIN.

The circuit board used for these tests was double-sided FR4 with 1 oz. copper on both sides.

5	SCREW	NOTE 3	PASSIVATED	2	SMA860A1-5
4	PAD	NOTE 1	NOTE 4	1	SMA860A1-4/5G
3	CONTACT PIN	NOTE 2	NOTE 5	1	SMA860A1-3/20G
2	INSULATOR	TEFLON		1	SMA860A1-2
1	BODY	NOTE 1	NOTE 4	1	SMA860A1-1/5G
NO.	DESCRIPTION	MATERIAL	FINISH	Q'TY	PART NO.

DIMENSION ARE MILLIMETERS UNLESS OTHERWISE SPECIFIED TOLERANCES
0.5~ 5= ±0.05
5~10 = ±0.07
10~20 = ±0.10
20~30 = ±0.15
30~ = ±0.20

SCALE	4 / 1	REV	-	UNIT	MM
APPROVE					
CHECKED					
DRAWN					

勝特力材料 886-3-5753170
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TITLE	FOLDER LOCK SMA JACK
DRAWING NO.	SMA860A1-0000